查询TPC\$8009-H供应商 TOSHIBA

TPCS8009-H

TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (MACH II π -MOS V)

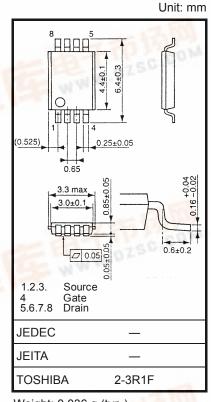
TPCS8009-H

High-Speed Switching Applications Switching Regulator Applications DC/DC Converter Applications

- Low drain-source ON-resistance: R_{DS} (ON) = 0.27 Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 2.1 \text{ S} (typ.)$
- Low leakage current: $I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 150 \ V)$
- Enhancement model: $V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, \text{I}_{D} = 1 \text{ mA})$

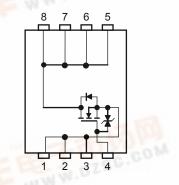
Characte	ristic	Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	150	V	
Drain-gat <mark>e</mark> voltage (R _{GS} = 20 kΩ)		V _{DGR}	150	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	Ι _D	2.1	A	
Drain current	Pulse (Note 1)	I _{DP}	8.4	A	
Drain power dissipation (t = 10 s) (Note 2a)		PD	1.5	w	
Drain power dissipatio	on (t = 10 s) (Note 2b)	PD	0.6	vv	
Single-pulse avalanche energy(Note3)		EAS	3	mJ	
Avalanche current		I _{AR}	2.1	А	
Repetitive avalanche energy (Note2a, Note 4)		E _{AR}	0.15	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	range	T _{stg}	-55~150	°C	

Absolute Maximum Ratings (Ta = 25°C)



Weight: 0.036 g (typ.)

Circuit Configuration



Note: For Notes 1 to 4, refer to the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

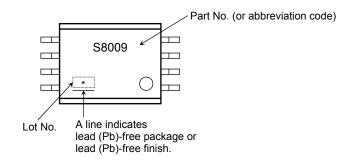
This transistor is an electrostatic-sensitive device. Handle with care.

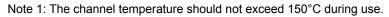


Thermal Characteristics

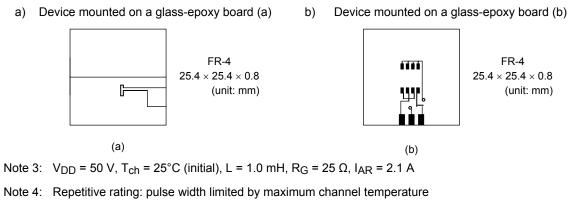
Characteristic	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	83.3	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	208	°C/W

Marking (Note 5)



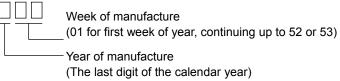


Note 2:



Note 5: O on the lower right of the marking indicates Pin 1.

* Weekly code: (Three digits)

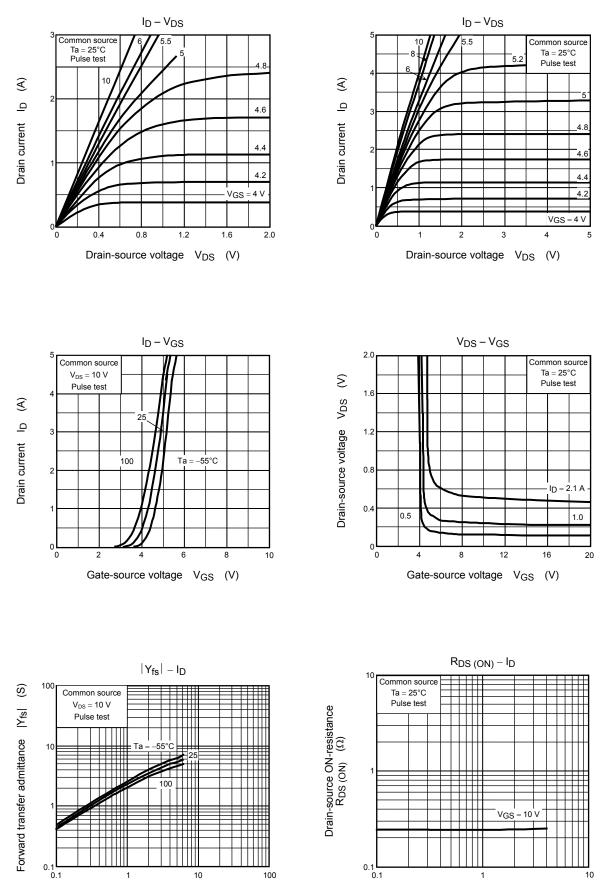


Electrical Characteristics (Ta = 25°C)

Ch	aracteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS}=\pm 16~V,~V_{DS}=0~V$	—	_	±10	μA
Drain cutoff curre	ent	I _{DSS}	$V_{DS} = 150 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			100	μA
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10 \text{ mA}, \text{ V}_{GS} = 0 \text{ V}$ $I_D = 10 \text{ mA}, \text{ V}_{GS} = -5 \text{ V}$	150			v
		V (BR) DSX		150		_	
		V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	100	_		
Gate threshold ve	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	2.0	_	4.0	V
Drain-source ON	-resistance	R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.0 \text{ A}$	_	0.27	0.35	Ω
Forward transfer admittance		Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1.0 \text{ A}$	0.9	2.1		S
Input capacitance		C _{iss}	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	_	600		pF
Reverse transfer capacitance		C _{rss}		_	20		pF
Output capacitance		C _{oss}		_	220		pF
Switching time	Rise time	tr	$V_{GS} \stackrel{10}{}_{0}V \int I_{D} = 1.0 \text{ A}$	_	35		
	Turn-on time	t _{on}		_	95	_	
	Fall time	t _f			20		ns
	Turn-off time	t _{off}	Duty ≦ 1%, t _w = 10 μs	_	120	_	
Total gate charge (gate-source plus		ate-drain) Qg - 10			nC		
Gate-source charge		Q _{gs}	V _{DD} ≃ 120V, V _{GS} = 10 V, I _D = 2.1 A	_	7.5	—	nC
Gate-drain ("Miller") charge		Q _{gd}	ן - 2. י א 		2.5		nC
Gate switch charge		Q _{sw}			3.3		nC

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current (pulse)	(Note 1)	I _{DRP}	—	_	_	8.4	А
Forward voltage (diode)		V _{DSF}	$I_{DR} = 2.1 \text{ A}, V_{GS} = 0 \text{ V}$		_	-2.0	V

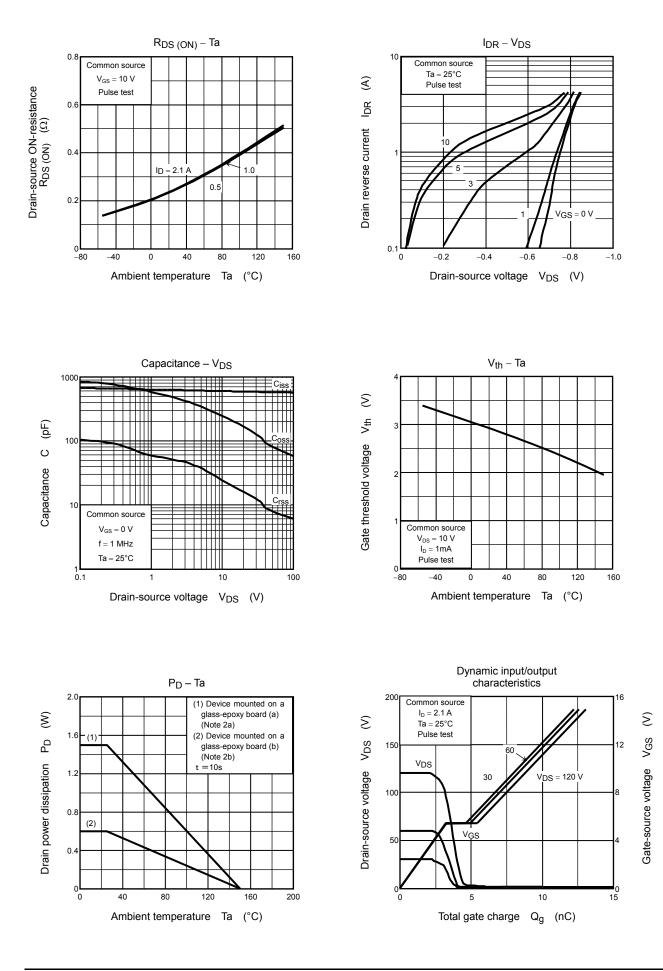


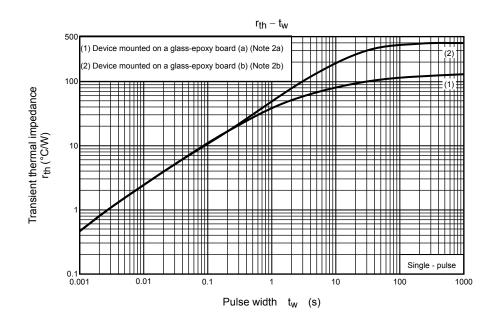
Drain current I_D (A)

4

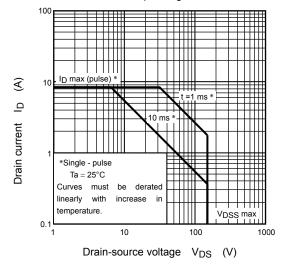
Drain current I_D (A)

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Safe operating area



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Handbook" etc.

20070701-EN

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